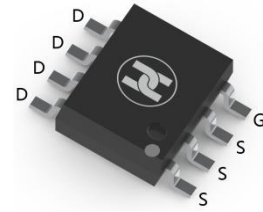
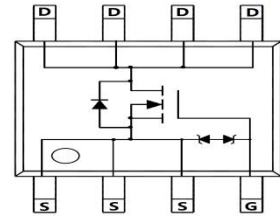


LOW VOLTAGE MOSFET (N-CHANNEL)
FEATURES

- Ultra low on-resistance: $V_{DS}=30V, I_D=23A, R_{DS(ON)} \leq 4m\Omega @ V_{GS}=10V$
- For boost converters and synchronous rectifiers applications
- For high frequency switching applications
- Surface Mount device


SOP-8

MECHANICAL DATA

- Case: SOP-8
- Case Material: Molded Plastic. UL flammability
- Classification Rating: 94V-0
- Weight: 0.3 grams (approximate)

MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DS}	30	V
Gate-source voltage	V_{GS}	± 20	V
Continuous drain current	I_D	$T_A = 25^\circ\text{C}$	23
		$T_A = 70^\circ\text{C}$	18
Pulsed drain current	I_{DM}	316	A
Avalanche current	I_{AS}, I_{AR}	49	A
Avalanche energy $L=0.1\text{mH}$	E_{AS}, E_{AR}	120	mJ
Power dissipation	P_D	$T_A = 25^\circ\text{C}$	3.6
		$T_A = 70^\circ\text{C}$	2.3
Thermal resistance from Junction to ambient	$R_{\theta JA}$	65	$^\circ\text{C/W}$
Thermal resistance from Junction to Lead	$R_{\theta JL}$	15	$^\circ\text{C/W}$
Junction temperature	T_J	150	$^\circ\text{C}$
Storage temperature	T_{STG}	-55 ~ +150	$^\circ\text{C}$

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Min	Typ	Max	Unit	Conditions
Drain-Source breakdown voltage	$V_{(BR)DSS}^*$	30	36		V	$V_{GS}=0V, I_D=250\mu\text{A}$
Zero gate voltage drain current	I_{DSS}^*			1	μA	$V_{DS}=30V, V_{GS}=0V$
Gate-body leakage current	I_{GSS}^*			± 100	μA	$V_{DS}=0V, V_{GS}=\pm 20V$
Gate-threshold voltage	$V_{GS(th)}^*$	1.3	1.8	2.3	V	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$
On-State Drain Current	$I_{D(ON)}$	316			A	$V_{DS}=5V, V_{GS}=10V$
Drain-source on-resistance	$R_{DS(ON)}^*$		3.2	4.0	$\text{m}\Omega$	$V_{GS}=10V, I_D=20A$
			4.8	6.0	$\text{m}\Omega$	$V_{GS}=10V, I_D=20A, T_J=125^\circ\text{C}$
			3.9	5.0	$\text{m}\Omega$	$V_{GS}=4.5V, I_D=18A$
Forward transconductance	g_{FS}		120		S	$V_{DS}=5V, I_D=20A$
Diode forward voltage	V_{SD}		0.7	1	V	$I_S=1A, V_{GS}=0V$
Diode forward current	I_S			5	A	
Input capacitance	C_{iss}	2310	2891	3470	pF	$V_{DS}=15V, V_{GS}=0V, f=1\text{MHz}$
Output capacitance	C_{oss}	330	474	620	pF	
Reverse transfer capacitance	C_{rss}	150	256	360	pF	
Gate resistance	R_g	0.7	1.6	2.4	Ω	$V_{DS}=0V, V_{GS}=0V, f=1\text{MHz}$
Total gate charge	Q_g	19	24.8	30	nC	$V_{GS}=4.5V, V_{DS}=15V, I_D=20A$
Total gate charge		41	51.9	63	nC	
Gate-source charge	Q_{gs}		7.0		nC	$V_{GS}=10V, V_{DS}=15V, I_D=20A$
Gate-drain charge	Q_{gd}		10.9		nC	
Turn-on delay time	$t_{d(on)}$		7.0		nS	$V_{GS}=10V, V_{DS}=15V, R_{GEN}=3\Omega, R_L=0.75\Omega$
Turn-on rise time	t_r		4.8		nS	
Turn-off delay time	$t_{d(off)}$		41.5		nS	
Turn-off fall time	t_f		8.8		nS	
Body Diode Reverse Recovery Time	t_{rr}	11	13.8	17	nS	
Body Diode Reverse Recovery Charge	Q_{rr}	24	30.8	37	nC	$I_F=20A, di/dt=500A/\mu\text{s}$

*Pulse test ; Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$.

LOW VOLTAGE MOSFET (N-CHANNEL)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

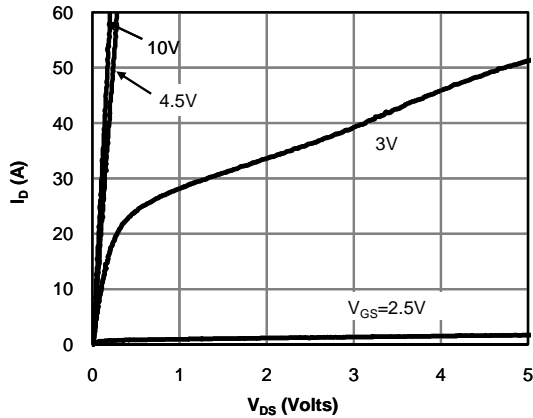


Fig 1: On-Region Characteristics

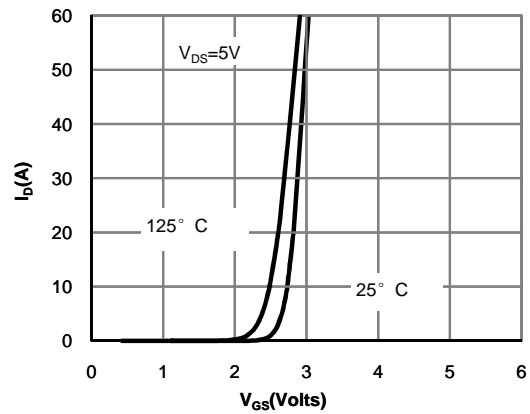


Figure 2: Transfer Characteristics

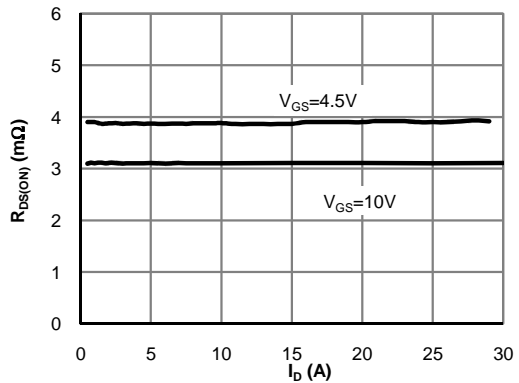


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

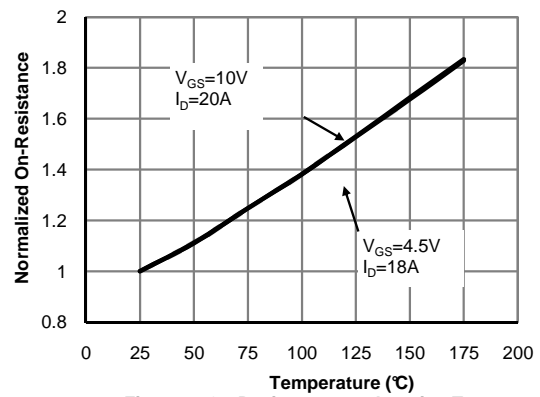


Figure 4: On-Resistance vs. Junction Temperature

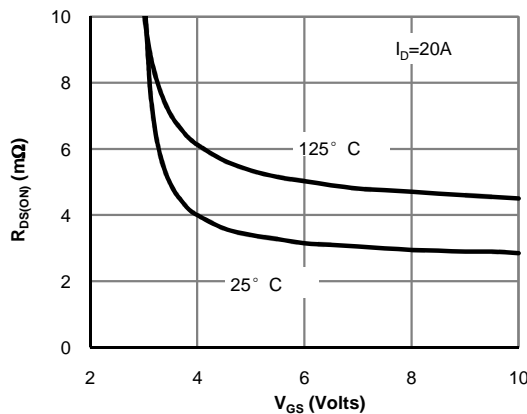


Figure 5: On-Resistance vs. Gate-Source Voltage

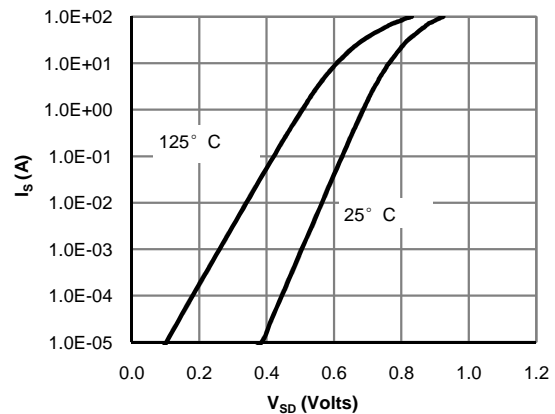


Figure 6: Body-Diode Characteristics

LOW VOLTAGE MOSFET (N-CHANNEL)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

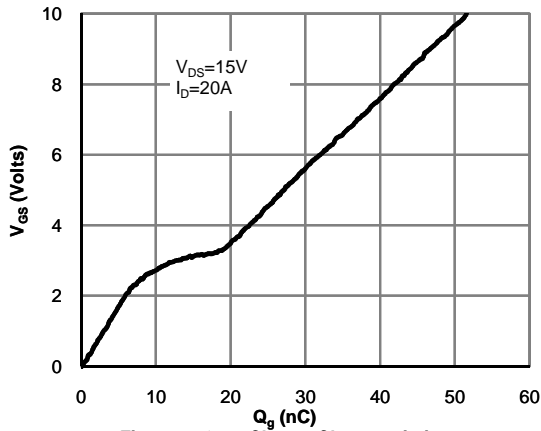


Figure 7: Gate-Charge Characteristics

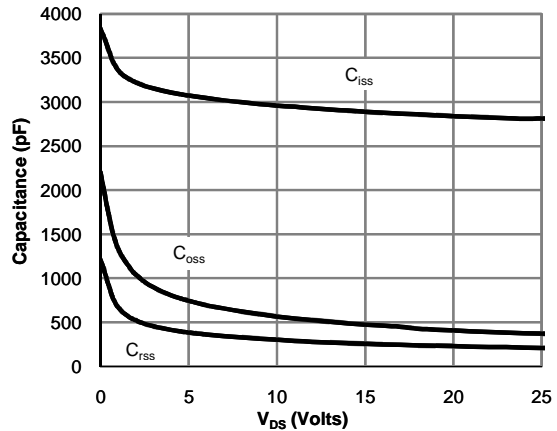


Figure 8: Capacitance Characteristics

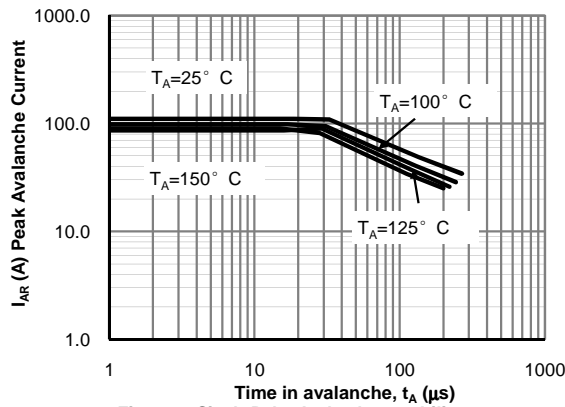


Figure 9: Single Pulse Avalanche capability

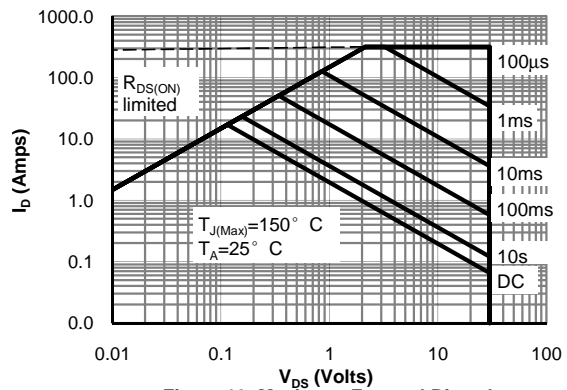


Figure 10: Maximum Forward Biased Safe Operating Area

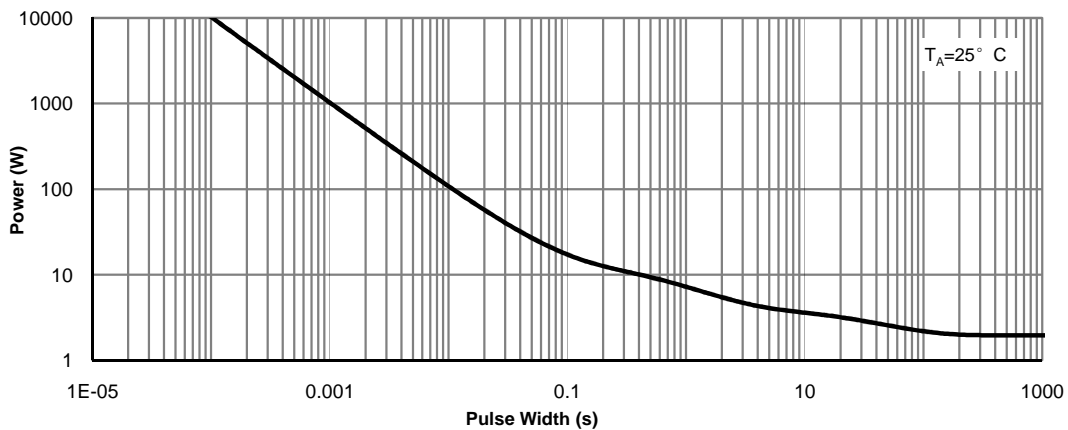
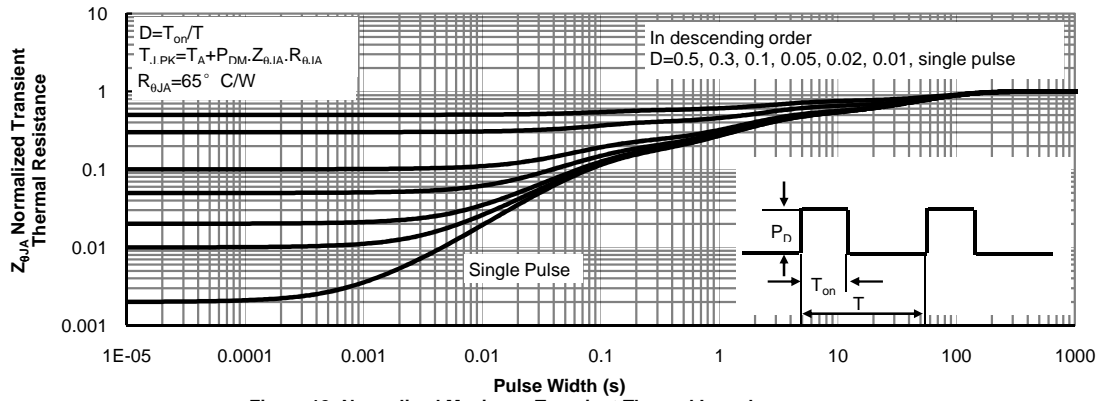


Figure 11: Single Pulse Power Rating Junction-to-Ambient

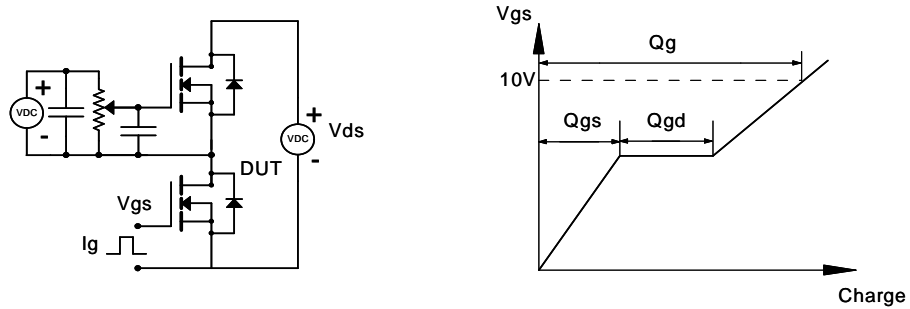
LOW VOLTAGE MOSFET (N-CHANNEL)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

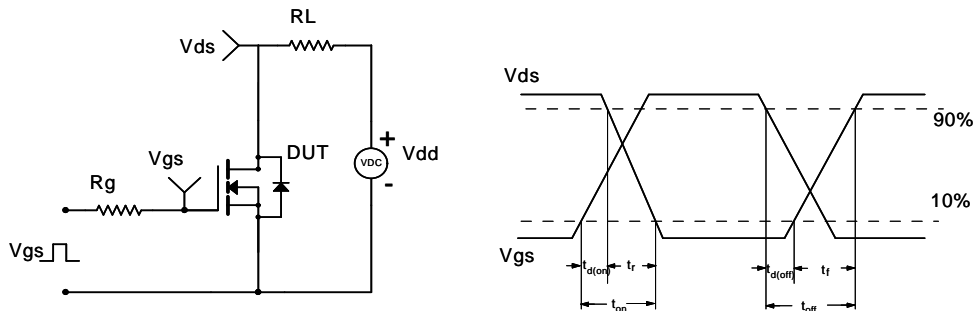


LOW VOLTAGE MOSFET (N-CHANNEL)

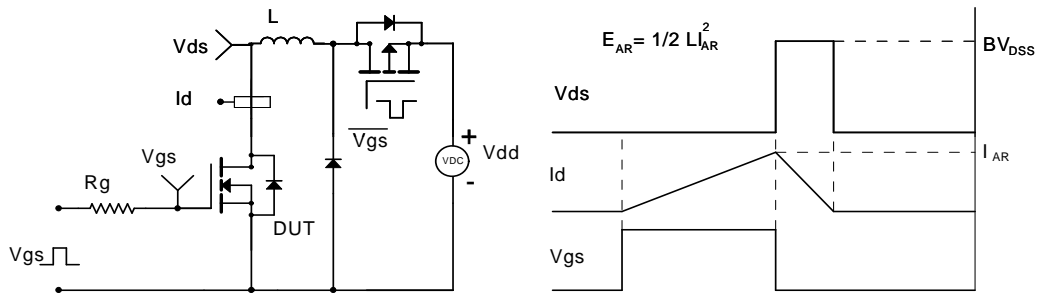
Gate Charge Test Circuit & Waveform



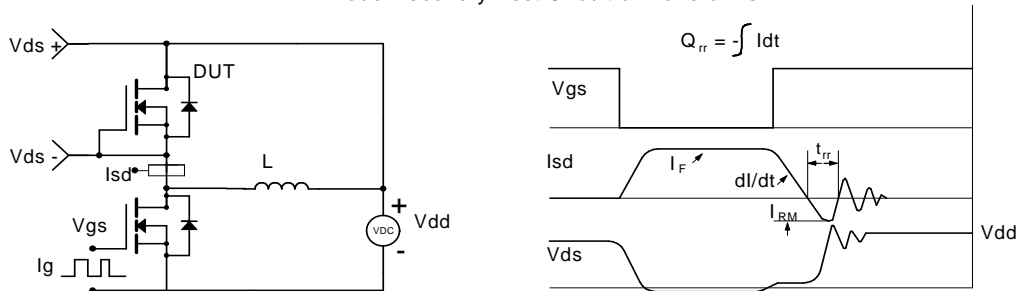
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

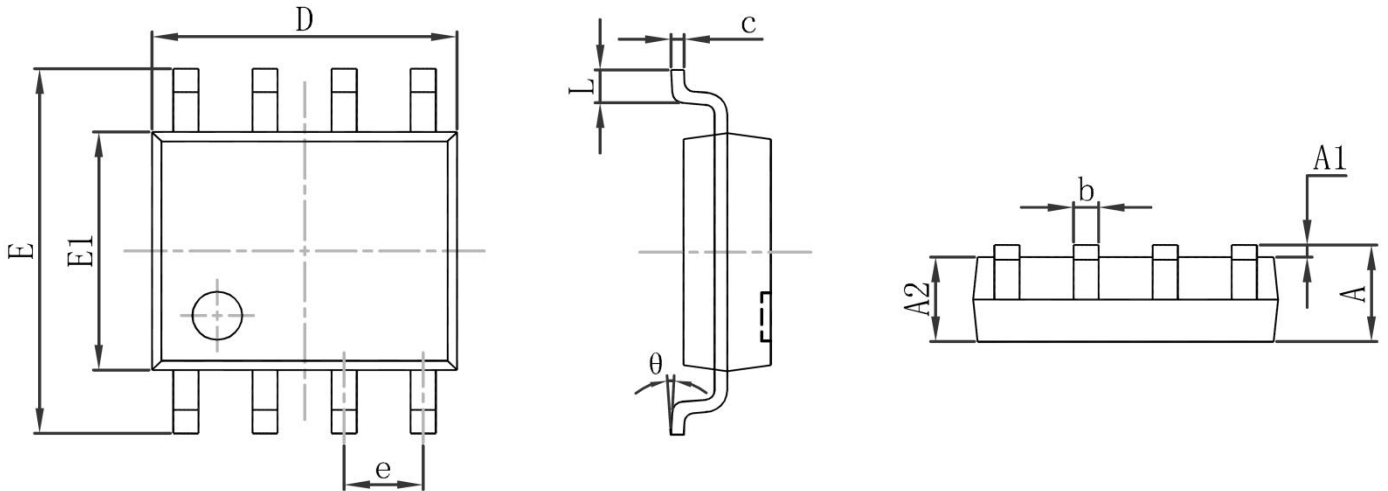


Diode Recovery Test Circuit & Waveforms



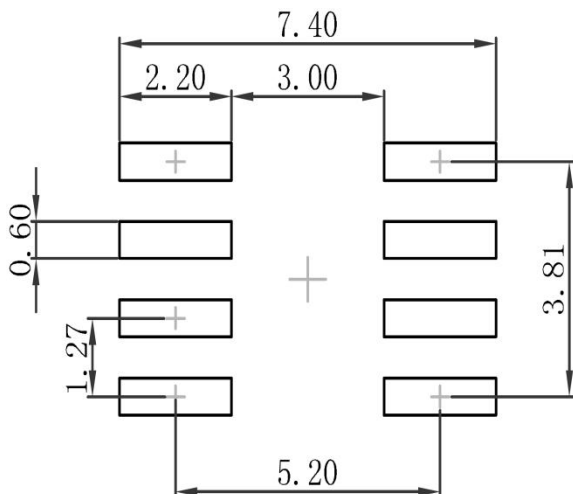
LOW VOLTAGE MOSFET (N-CHANNEL)

SOP-8 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.007	0.010
D	4.800	5.000	0.189	0.197
e	1.270(BSC)		0.050 (BSC)	
E	5.800	6.200	0.228	0.244
E1	3.800	4.000	0.150	0.157
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

SOP-8 Suggested Pad Layout



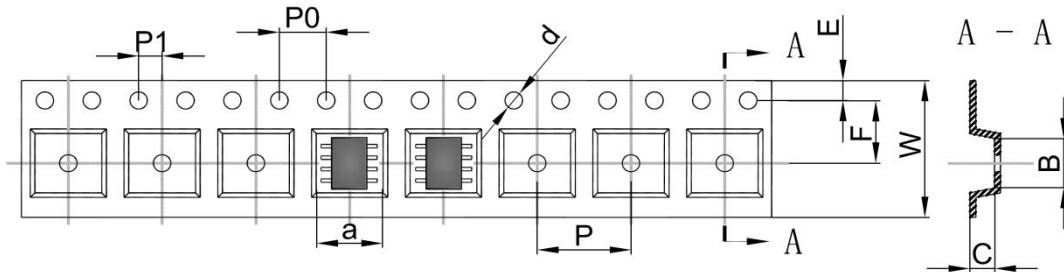
Note:

1. Controlling dimension: in millimeters
2. General tolerance: ±0.05mm
3. The pad layout is for reference purposes only

LOW VOLTAGE MOSFET (N-CHANNEL)

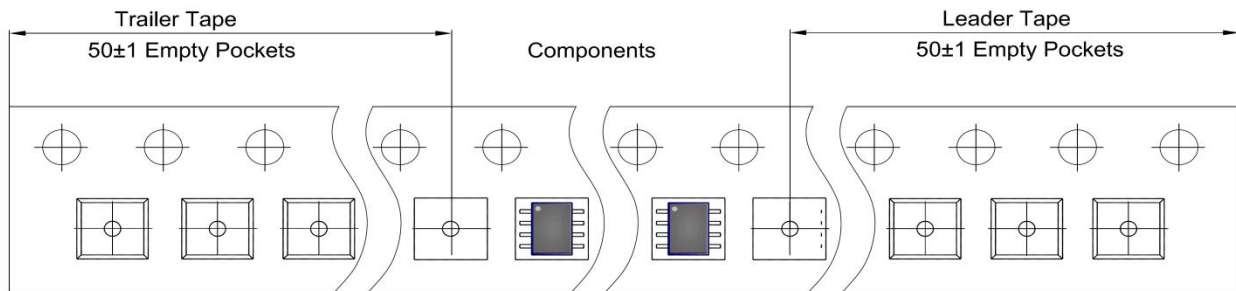
SOP-8 Tape and Reel

SOP-8 Embossed Carrier Tape

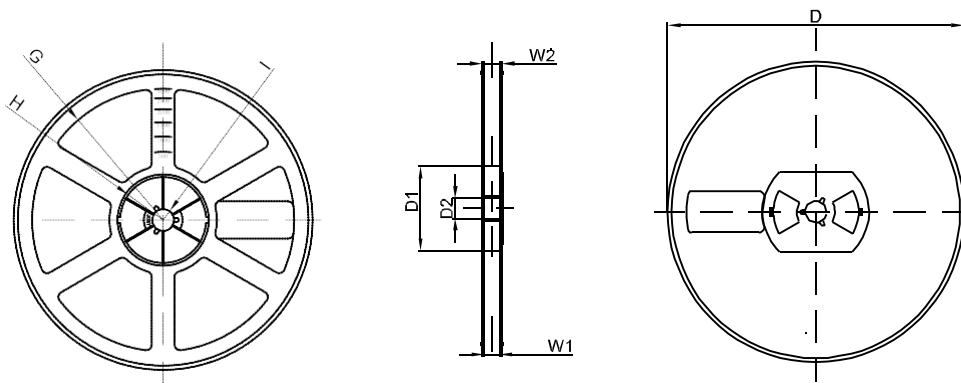


DIMENSIONS ARE IN MILLIMETER										
TYPE	A	B	C	d	E	F	P0	P	P1	W
SOP-8	6.40	5.40	2.10	Ø1.50	1.75	5.50	4.00	8.00	2.00	12.00
TOLERANCE	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1

SOP-8 Tape Leader and Trailer



SOP-8 Reel



DIMENSIONS ARE IN MILLIMETER								
REEL OPTION	D	D1	D2	G	H	I	W1	W2
13" DIA	Ø330.00	100.00	13.00	R151.00	R56.00	R6.50	12.40	17.60
TOLERANCE	±2	±1	±1	±1	±1	±1	±1	±1